

Current Mode Control High Speed Frequency

Internal 1A MOSFET Switching Regulator IC for Buck Converter

■ GENERAL DESCRIPTION

The **NJW4170** is a high speed oscillating frequency buck converter with **40V/1A** MOSFET. Current mode control and built-in phase compensation circuit minimize external parts and contribute to using a Low ESR Output Capacitor(MLCC) within wide input range from 4.5V to 40V. Therefore, the **NJW4170** can realize downsizing of applications.

Also, it has a soft start function, an external clock synchronization function, an over current protection and a thermal shutdown circuit.

Over 2MHz of Switching frequency can avoid interference with the AM radio frequency.

It is suitable for supplying power to a Car Accessory, Audio Automation Equipment, Industrial Instrument and so on.

■ PACKAGE OUTLINE



NJW4170U2



NJW4170KV1

■ FEATURES

Oscillating Frequency
 2.4MHz typ. (A ver.)

2.1MHz typ. (B ver.)

Minimum ON time
 80ns typ.(A ver.)

85ns typ.(B ver.)

Current mode Control

External Clock Synchronization

Wide Operating Voltage Range 4.5V to 40VSwitching Current 1.4A min.

PWM Control

Built-in Compensation Circuit

Correspond to Ceramic Capacitor (MLCC)

Soft Start Function
 4ms typ.

UVLO (Under Voltage Lockout)

Over Current Protection (Hiccup type)

Thermal Shutdown Protection

Standby Function

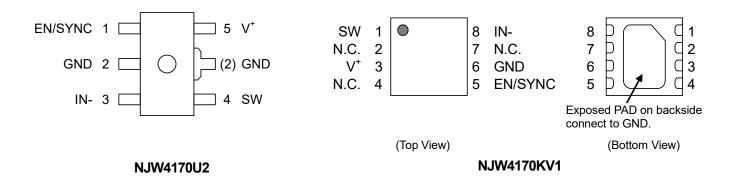
◆ Package Outline
NJW4170U2 : SOT-89-5

NJW4170KV1: DFN8-V1(ESON8-V1)

■ PRODUCT CLASSIFICATION

Part Number	Version	Oscillating Frequency	Package	Operating Temperature Range
NJW4170U2-A	А	2.4MHz typ.	SOT-89-5	General Spec. -40°C to +125°C
NJW4170KV1-A	Α	2.4MHz typ.	DFN8-V1 (ESON8-V1)	General Spec. -40°C to +125°C
NJW4170U2-B	В	2.1MHz typ.	SOT-89-5	General Spec. -40°C to +125°C

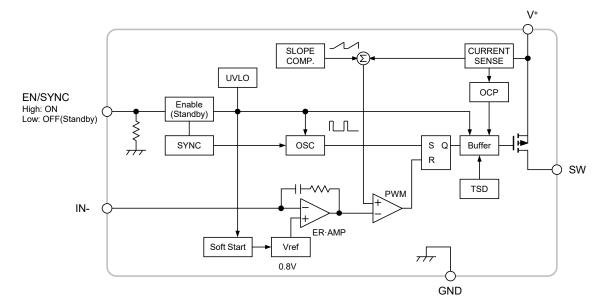
■ PIN CONFIGURATION



■ PIN DESCRIPTIONS

	PIN NUMBER			
PIN NAME	SOT-89-5	DFN8-V1 (ESON8)	FUNCTION	
EN/SYNC	1	5	Standby Control pin The EN/SYNC pin internally pulls down with $100 \mathrm{k}\Omega$. Normal Operation at the time of High Level. Standby Mode at the time of Low Level or OPEN. Moreover, it operates by inputting clock signal at the oscillatory frequency that synchronized with the input signal.	
GND	2	6	GND pin	
IN-	3	8	Output Voltage Detecting pin Connects output voltage through the resistor divider tap to this pin in order to voltage of the IN- pin become 0.8V.	
SW	4	1	Switch Output pin of Power MOSFET	
V ⁺	5	3	Power Supply pin for Power Line	
N.C.	_	2, 4, 7	Non connection	
Exposed PAD	_	_	Connect to GND (Only DFN8-V1 PKG)	

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

PARAMETER	SYMBOL	MAXIMUM RATINGS		UNIT	
Supply Voltage	V ⁺	-0.3 to	-0.3 to +45		
V⁺- SW pin Voltage	V_{V-SW}	+4:	+45		
EN/SYNC pin Voltage	V _{EN/SYNC}	-0.3 to	+45	V	
IN- pin Voltage	V _{IN-}	-0.3 to +6		V	
	_	SOT-89-5	625 (*1) 2,400 (*2)	mW	
Power Dissipation	P _D	DFN8-V1 (ESON8-V1)	600 (*3) 1,800 (*4)		
Junction Temperature Range	Tj	-40 to	+150	°C	
Operating Temperature Range	T _{opr}	-40 to +125		°C	
Storage Temperature Range	T _{stg}	-50 to +150		°C	

^{(*1):} Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard size, 2Layers, Cu area 100mm²)

(*3): Mounted on glass epoxy board. (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 2Layers FR-4, with Exposed Pad)

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V ⁺	4.5	_	40	V
External Clock Input Range					
A version	f sync	2.3	_	2.8	MHz
B version		2.0	_	2.5	

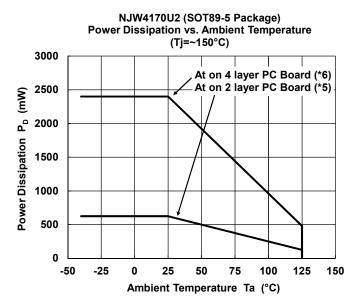
^{(*2):} Mounted on glass epoxy board. (76.2×114.3×1.6mm:based on EIA/JDEC standard, 4Layers)
(For 4Layers: Applying 74.2×74.2mm inner Cu area and a thermal via hall to a board based on JEDEC standard JESD51-5)

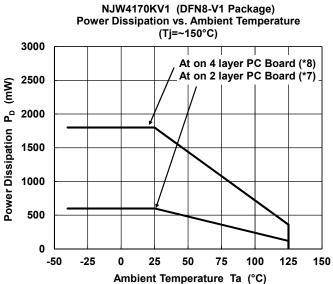
^{(*4):} Mounted on glass epoxy board. (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 4Layers FR-4, with Exposed Pad) (For 4Layers: Applying 99.5×99.5mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5)

■ ELECTRICAL CHARACTERISTICS		(Unless otherwise noted, V*=V _{EN/SYNC} =12V, Ta=25°C)				
PARAMETER SYMBOL		TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Under Voltage Lockout Block						
ON Threshold Voltage	V_{T_ON}	$V^+=L \rightarrow H$	4.2	4.35	4.5	V
OFF Threshold Voltage	V _{T_OFF}	V+= H → L	4.11	4.26	4.41	V
Hysteresis Voltage	V _{HYS}		70	90	_	mV
Soft Start Block						
Soft Start Time	t _{SS}	V _B =0.75V	2.5	4	8	ms
Oscillator Block						
Oscillating Frequency	f _{OSC}	A version, V _{IN} -=0.7V	2.2	2.4	2.6	MHz
	1050	B version, V _{IN} =0.7V	1.9	2.1	2.3	MHz
Oscillating Frequency	f _{OSC_LOW}	A version, V _{IN} =0.2V	_	340	_	kHz
(Low Frequency Control) Oscillating Frequency		B version, V _{IN-} =0.2V		290	_	kHz
deviation (Supply voltage)	f _{DV}	V+=4.5 to 40V	_	1	_	%
Oscillating Frequency deviation (Temperature)	f _{DT}	Ta= -40°C to +85°C	_	5	_	%
Error Amplifier Block						
Reference Voltage	V _B		-1.0%	0.8	+1.0%	V
Input Bias Current	l _Β		-0.1	_	+0.1	μΑ
PWM Comparate Block						
Maximum Duty Cycle	M _{AX} D _{UTY}	A, B version, V _{IN-} =0.7V	77.5	82	_	%
Minimum ON Time1	t	A version	_	80	115	ns
(Use Built-in Oscillator)	t _{ON-min1}	B version	_	85	120	ns
Minimum ON Time2	t	A version, f _{SYNC} =2.6kHz	_	80	115	ns
(Use Ext CLK)	t _{ON-min2}	B version, f _{SYNC} =2.3kHz	_	85	120	ns

■ ELECTRICAL CHARACTERISTICS		(Unless otherwise	(Unless otherwise noted, V ⁺ =V _{EN/SYNC} =12V, Ta=25°C)				
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Over Current Protection Block							
Cool Down Time	tcool		_	75	_	ms	
Output Block							
Output ON Resistance	Ron	I _{SW} =1A	_	0.4	0.65	Ω	
Switching Current Limit	I _{LIM}		1.4	1.9	2.4	Α	
SW Leak Current	I _{LEAK}	V _{EN/SYNC} =0V, V ⁺ =40V, V _{SW} =0V	_	_	1	μΑ	
Standby Control / Sync Block EN/SYNC pin	VTHH EN/SYNC	$V_{EN/SYNC}=L \rightarrow H$	1.6	_	V ⁺	V	
High Threshold Voltage EN/SYNC pin Low Threshold Voltage	V _{THL_EN/SYNC}	$V_{\text{EN/SYNC}} = H \rightarrow L$	0	_	0.5	V	
Input Bias Current (EN/SYNC pin)	I _{EN}	V _{EN/SYNC} =12V	_	270	390	μА	
General Characteristics							
Quiescent Current	I _{DD}	A, B version, R _L =no load, V _{IN-} =0.9V	_	2.0	2.4	mA	
Standby Current	I _{DD_STB}	V _{EN/SYNC} =0V	_	ı	1	μ A	

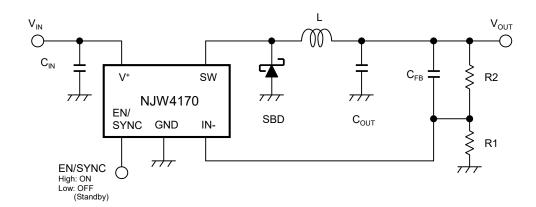
■ POWER DISSIPATION vs. AMBIENT TEMPERATURE



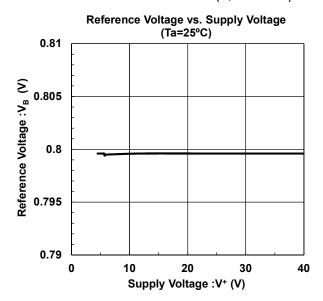


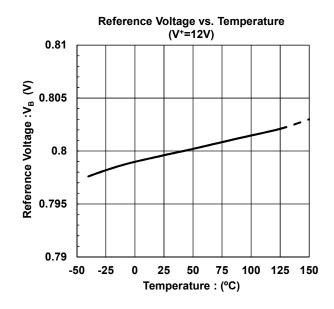
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- (*7): Mounted on glass epoxy board. (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 2Layers FR-4, with Exposed Pad) (*8): Mounted on glass epoxy board. (101.5×114.5×1.6mm: based on EIA/JEDEC standard, 4Layers FR-4, with Exposed Pad) (For 4Layers: Applying 99.5×99.5mm inner Cu area and a thermal via hole to a board based on JEDEC standard JESD51-5)

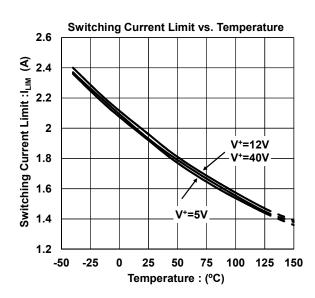
■ TYPICAL APPLICATIONS

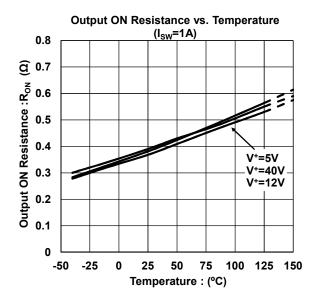


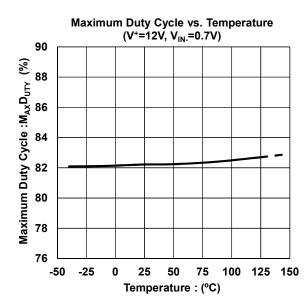
■ TYPICAL CHARACTERISTICS (A, B version)



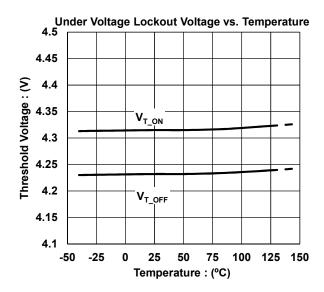


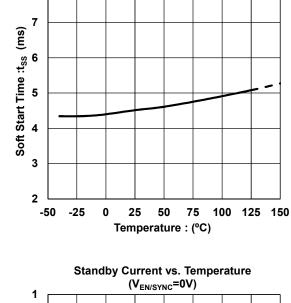






■ TYPICAL CHARACTERISTICS (A, B version)

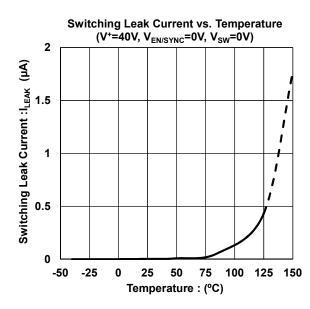


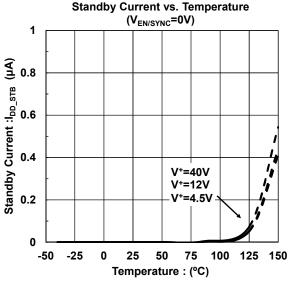


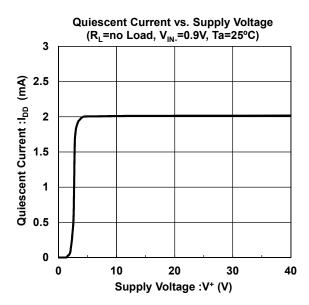
Soft Start Time vs. Temperature

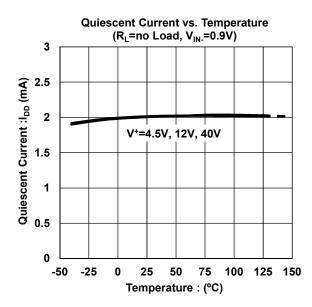
 $(V^{+}=12V, V_{B}=0.75V)$

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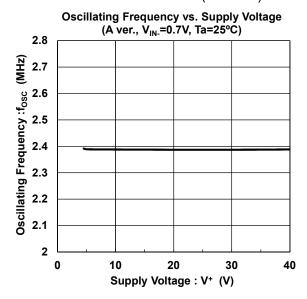


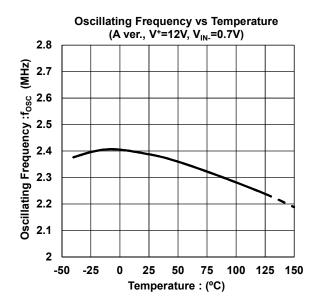


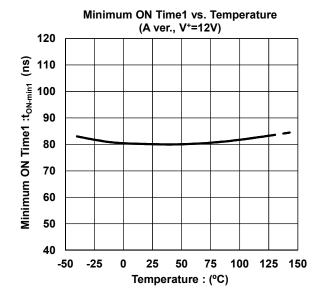




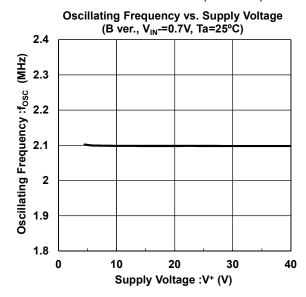
■ TYPICAL CHARACTERISTICS (A version)

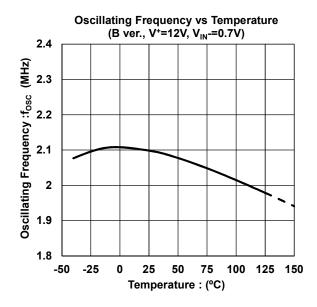


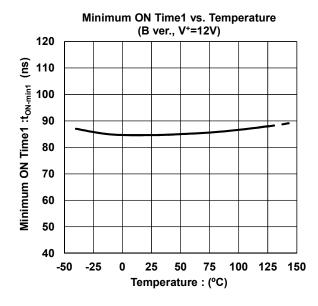




■ TYPICAL CHARACTERISTICS (B version)







Technical Information

■ Description of Block Features

1. Basic Functions / Features

Error Amplifier Section (ER·AMP)

0.8V±1% precise reference voltage is connected to the non-inverted input of this section.

To set the output voltage, connects converter's output to inverted input of this section (IN- pin). If requires output voltage over 0.8V, inserts resistor divider.

Because the optimized compensation circuit is built-in, the application circuit can be composed of minimum external parts.

PWM Comparator Section (PWM), Oscillating Circuit Section (OSC)

The NJW4170 uses a constant frequency, current mode step down architecture. The oscillating frequency are 2.4MHz (typ.) at A version and 2.1MHz (typ.) at B version. The PWM signal is output by feedback of output voltage and slope compensation switching current at the PWM comparator block.

The maximum duty ratio is 82% (typ.).

The minimum ON time are limited to 80ns (typ.) at A version and 85ns (typ.) at B version.

The buck converter of ON time is decided the following formula.

$$ton = \frac{V_{\text{OUT}}}{V_{\text{IN}} \times f_{\text{OSC}}} \left[s \right]$$

 V_{IN} shows input voltage and V_{OUT} shows output voltage.

When the ON time becomes below in t_{ON-min}, in order to maintain output voltage at a stable state, change of duty or pulse skip operation may be performed.

Power MOSFET (SW Output Section)

The power is stored in the inductor by the switch operation of built-in power MOSFET. The output current is limited to 1.4A(min.) the overcurrent protection function. In case of step-down converter, the forward direction bias voltage is generated with inductance current that flows into the external regenerative diode when MOSFET is turned off.

The SW pin allows voltage between the V⁺ pin and the SW pin up to +45V. However, you should use an Schottky diode that has low saturation voltage.

Power Supply, GND pin (V⁺ and GND)

In line with switching element drive, current flows into the IC according to frequency. If the power supply impedance provided to the power supply circuit is high, it will not be possible to take advantage of IC performance due to input voltage fluctuation. Therefore insert a bypass capacitor close to the V⁺ pin – the GND pin connection in order to lower high frequency impedance.

- Description of Block Features (Continued)
- 2. Additional and Protection Functions / Features
 - Under Voltage Lockout (UVLO)

The UVLO circuit operating is released above $V^+=4.35V(typ.)$ and IC operation starts. When power supply voltage is low, IC does not operate because the UVLO circuit operates. There is 90mV(typ.) width hysteresis voltage at rise and decay of power supply voltage. Hysteresis prevents the malfunction at the time of UVLO operating and releasing.

Soft Start Function (Soft Start)

The output voltage of the converter gradually rises to a set value by the soft start function. The soft start time is 4ms (typ.). It is defined with the time of the error amplifier reference voltage becoming from 0V to 0.75V. The soft start circuit operates after the release UVLO and/or recovery from thermal shutdown. The operating frequency is controlled with a low frequency 340kHz (typ.) at A version and 290kHz (typ.) at B version, until voltage or the IN- pin becomes approximately 0.4V.

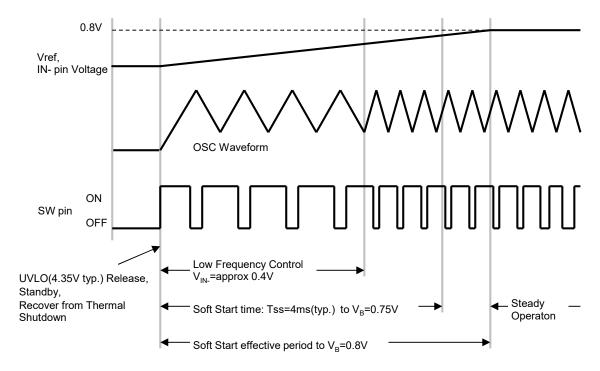


Fig. 1. Startup Timing Chart

Technical Information

- Description of Block Features (Continued)
 - Over Current Protection Circuit (OCP)

NJW4170 contains overcurrent protection circuit of hiccup architecture. The overcurrent protection circuit of hiccup architecture is able to decrease heat generation at the overload.

The NJW4170 output returns automatically along with release from the over current condition.

At when the switching current becomes I_{LIM} or more, the overcurrent protection circuit is stopped the MOSFET output. The switching output holds low level down to next pulse output at OCP operating.

When IN- pin voltage becomes 0.3V or less, it operates with 340kHz (typ.) at A version and 290kHz (typ.) at B version.

At the same time starts pulse counting, and stops the switching operation when the overcurrent detection continues 128 pulses.

After NJW4170 switching operation was stopped, it restarts by soft start function after the cool down time of approx 75ms (typ.).

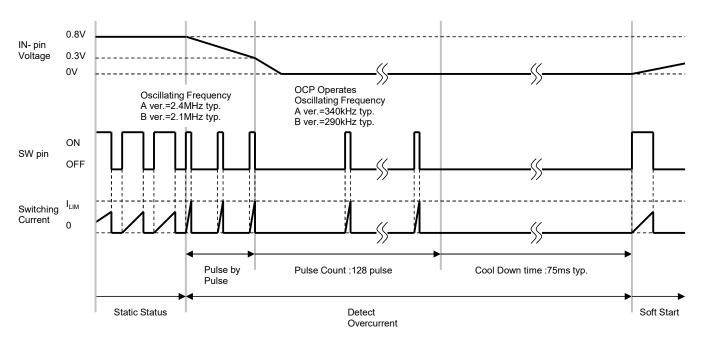


Fig. 2. Timing Chart at Over Current Detection

Thermal Shutdown Function (TSD)

When Junction temperature of the NJW4170 exceeds the 165°C*, internal thermal shutdown circuit function stops SW function. When junction temperature decreases to 150°C* or less, SW operation returns with soft start operation.

The purpose of this function is to prevent malfunctioning of IC at the high junction temperature. Therefore it is not something that urges positive use. You should make sure to operate within the junction temperature range rated (150°C). (* Design value)

Standby Function

The NJW4170 stops the operating and becomes standby status when the EN/SYNC pin becomes less than 0.5V. The EN/SYNC pin internally pulls down with $100k\Omega$, therefore the NJW4170 becomes standby mode when the EN/SYNC pin is OPEN. You should connect this pin to V⁺ when you do not use standby function.

- Description of Block Features (Continued)
 - External Clock Synchronization

By inputting a square wave to EN/SYNC pin, can be synchronized to an external frequency. You should fulfill the following specification about a square wave. (Table 1.)

Table 1. The input square wave to an EN/SYNC pin.

	A version	B version			
	$(f_{OSC} = 2.4MHz)$	(f _{OSC} =2.1MHz)			
Input Frequency	2.3MHz to 2.8MHz	2.0MHz to 2.5MHz			
Duty Cycle	40% to 60%				
Voltage	1.6V or more at High level				
magnitude	0.5V or less at Low level				

The trigger of the switching operating at the external synchronized mode is detected to the rising edge of the input signal. At the time of switching operation from standby or asynchronous to synchronous operation, it has set a delay time approx $5\mu s$ to $10\mu s$ in order to prevent malfunctions. (Fig. 3.)

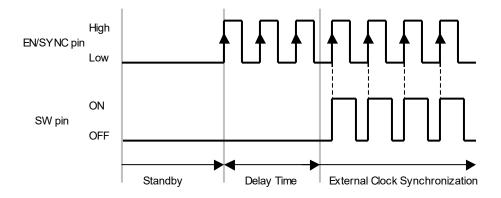


Fig. 3. Switching Operation by External Synchronized Clock

Technical Information

■ Application Information

Inductors

Because a large current flows to the inductor, you should select the inductor with the large current capacity not to saturate. Optimized inductor value is determined by the input voltage and output voltage.

Reducing L decreases the size of the inductor. However a peak current increases and adversely affects the efficiency. (Fig. 4.)

Moreover, you should be aware that the output current is limited because it becomes easy to operating to the overcurrent limit.

The peak current is decided the following formula.

$$\Delta I_{L} = \frac{\left(V_{IN} - V_{OUT}\right) \times V_{OUT}}{L \times V_{IN} \times f_{OSC}} [A]$$

$$lpk = l_{OUT} + \frac{\Delta l_{L}}{2} [A]$$

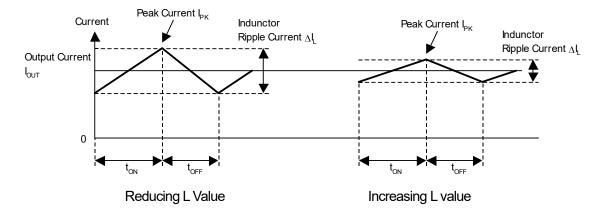


Fig. 4. Inductor Current State Transition (Continuous Conduction Mode)

Technical Information

■ Application Information (Continued)

Input Capacitor

Transient current flows into the input section of a switching regulator responsive to frequency. If the power supply impedance provided to the power supply circuit is large, it will not be possible to take advantage of the NJW4170 performance due to input voltage fluctuation. Therefore insert an input capacitor as close to the MOSFET as possible. A ceramic capacitor is the optimal for input capacitor.

The effective input current can be expressed by the following formula.

$$I_{RMS} = I_{OUT} \times \frac{\sqrt{V_{OUT} \times (V_{IN} - V_{OUT})}}{V_{IN}} [A]$$

In the above formula, the maximum current is obtained when $V_{IN} = 2 \times V_{OUT}$, and the result in this case is $I_{RMS} = I_{OUT\,(MAX)} \div 2$.

When selecting the input capacitor, carry out an evaluation based on the application, and use a capacitor that has adequate margin.

Output Capacitor

An output capacitor stores power from the inductor, and stabilizes voltage provided to the output. Because NJW4170 corresponds to the output capacitor of low ESR, the ceramic capacitor is the optimal for compensation.

In addition, you should consider varied characteristics of capacitor (a frequency characteristic, a temperature characteristic, a DC bias characteristic and so on) and unevenness peculiar to a capacitor supplier enough.

Therefore when selecting a capacitors, you should confirm the characteristics with supplier datasheets.

When selecting an output capacitor, you must consider Equivalent Series Resistance (ESR) characteristics, ripple current, and breakdown voltage.

The output ripple noise can be expressed by the following formula.

$$V_{\text{ripple(p-p)}} = \Delta I_{\text{L}} \times \Biggl(\text{ESR} + \frac{1}{8 \times f_{\text{OSC}} \times C_{\text{OUT}}} \Biggr) [V]$$

The effective ripple current that flows in a capacitor (I_{ms}) is obtained by the following equation.

$$I_{rms} = \frac{\Delta I_L}{2\sqrt{3}} [Arms]$$

Technical Information

- Application Information (Continued)
 - Catch Diode

When the switch element is in OFF cycle, power stored in the inductor flows via the catch diode to the output capacitor. Therefore during each cycle current flows to the diode in response to load current. Because diode's forward saturation voltage and current accumulation cause power loss, a Schottky Barrier Diode (SBD), which has a low forward saturation voltage, is ideal.

An SBD also has a short reverse recovery time. If the reverse recovery time is long, through current flows when the switching transistor transitions from OFF cycle to ON cycle. This current may lower efficiency and affect such factors as noise generation.

Setting Output Voltage, Compensation Capacitor

The output voltage V_{OUT} is determined by the relative resistances of R1, R2. The current that flows in R1, R2 must be a value that can ignore the bias current that flows in ER AMP.

$$V_{OUT} = \left(\frac{R2}{R1} + 1\right) \times V_B [V]$$

The zero points are formed with R2 and C_{FB} , and it makes for the phase compensation of NJW4170. The zero point is shown the following formula.

$$\textbf{f}_{z_1} = \frac{1}{2 \times \pi \times R2 \times \textbf{C}_{\text{FB}}} \left[\textbf{Hz} \right]$$

You should set the zero point as a guide from 60kHz to 80kHz.

- Application Information (Continued)
 - Board Layout

In the switching regulator application, because the current flow corresponds to the oscillating frequency, the substrate (PCB) layout becomes an important.

You should attempt the transition voltage decrease by making a current loop area minimize as much as possible. Therefore, you should make a current flowing line thick and short as much as possible. Fig.5. shows a current loop at step-down converter. Especially, should lay out high priority the loop of C_{IN} -SW-SBD that occurs rapid current change in the switching. It is effective in reducing noise spikes caused by parasitic inductance.

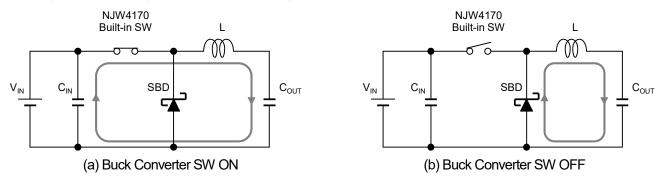


Fig. 5. Current Loop at Buck Converter

Concerning the GND line, it is preferred to separate the power system and the signal system, and use single ground point.

The voltage sensing feedback line should be as far away as possible from the inductance. Because this line has high impedance, it is laid out to avoid the influence noise caused by flux leaked from the inductance.

Fig. 6. shows example of wiring at buck converter. Fig. 7 shows the PCB layout example.

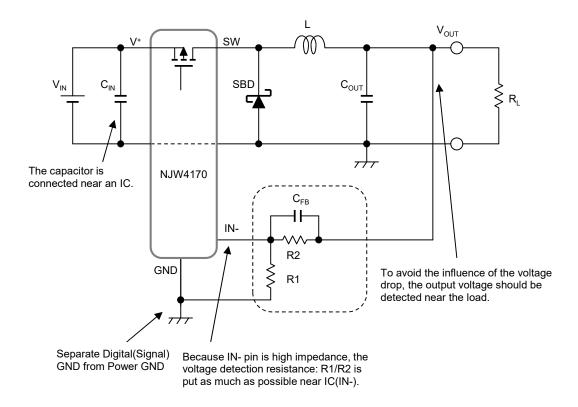
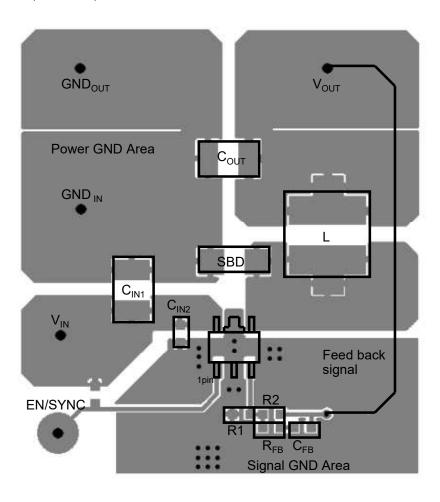


Fig. 6. Board Layout at Buck Converter

■ Application Information (Continued)



Connect Signal GND line and Power GND line on backside pattern

Fig. 7. Layout Example (upper view)

Technical Information

■ Calculation of Package Power

A lot of the power consumption of buck converter occurs from the internal switching element (Power MOSFET). Power consumption of NJW4170 is roughly estimated as follows.

Input Power: $P_{IN} = V_{IN} \times I_{IN} \quad [W]$ Output Power: $P_{OUT} = V_{OUT} \times I_{OUT} \quad [W]$

Diode Loss: $P_{DIODE} = V_F \times I_{L(avg)} \times OFF duty$ [W] NJW4170 Power Consumption: $P_{LOSS} = P_{IN} - P_{OUT} - P_{DIODE}$ [W]

Where:

 $\begin{array}{lll} V_{IN} & : Input \ Voltage \ for \ Converter & I_{IN} & : Input \ Current \ for \ Converter \\ V_{OUT} & : Output \ Voltage \ of \ Converter & I_{OUT} & : Output \ Current \ of \ Converter \\ V_F & : Diode's \ Forward \ Saturation \ Voltage & I_{L(avg)} & : Inductor \ Average \ Current \end{array}$

OFF duty : Switch OFF Duty

Efficiency (η) is calculated as follows.

$$\eta = (P_{OUT} \div P_{IN}) \times 100 \, [\%]$$

You should consider temperature derating to the calculated power consumption: PD.

You should design power consumption in rated range referring to the power dissipation vs. ambient temperature characteristics.

Technical Information

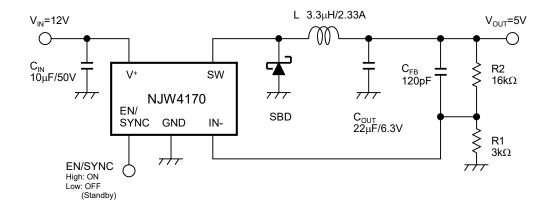
■ Application Design Examples

Buck Converter Application Circuit

 $\begin{array}{lll} \text{IC} & : \text{NJW4170U2} \\ \text{Input Voltage} & : \text{V}_{\text{IN}} = 12 \text{V} \\ \text{Output Voltage} & : \text{V}_{\text{OUT}} = 5 \text{V} \\ \text{Output Current} & : \text{I}_{\text{OUT}} = 1 \text{A} \end{array}$

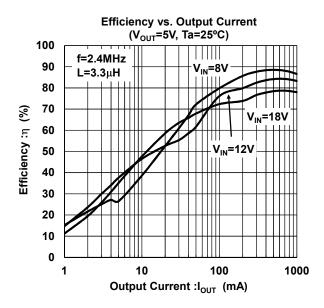
Oscillating frequency : A version fosc=2.4MHz

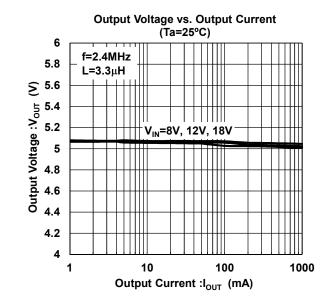
: B version f_{OSC}=2.1MHz



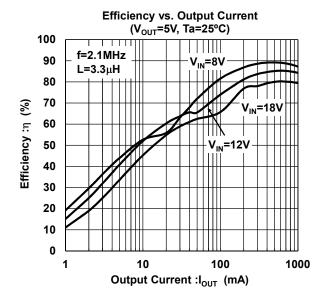
Reference	Qty.	Part Number	Description	Manufacturer
IC	1	NJW4170U2	Internal 1A MOSFET SW.REG. IC	New JRC
L	1	VLF504015MT-3R3M	Inductor 3.3μH, 2.33A	TDK
SBD	1	CMS16	Schottky Diode 40V, 3A	Toshiba
C _{IN}	1	UMK325BJ106MM	Ceramic Capacitor 3225 10µF, 50V, X5R	Taiyo Yuden
C _{OUT}	1	GRM31CB30J226ME18	Ceramic Capacitor 3216 22µF, 6.3V, B	Murata
C _{FB}	1	120pF	Ceramic Capacitor 1608 120pF, 50V, CH	Std.
R1	1	3kΩ	Resistor 1608 3kΩ, ±1%, 0.1W	Std.
R2	1	16kΩ	Resistor 1608 16kΩ, ±1%, 0.1W	Std.

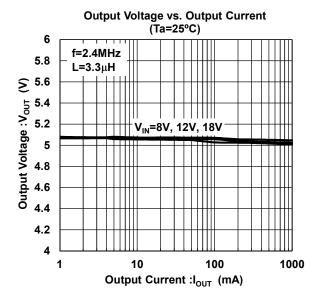
- Application Characteristics
 - A version





B version





MEMO

[CAUTION]
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